MC10EL07, MC10EL07

5.0 V ECL 2-Input XOR/XNOR

The MC10EL/100EL07 is a 2-input XOR/XNOR gate. The device is functionally equivalent to the E107 device with higher performance capabilities. With propagation delays and output transition times significantly faster than the E107, the EL07 is ideally suited for those applications which require the ultimate in AC performance.

The 100 Series contains temperature compensation.

Features

- 260 ps Propagation Delay
- ESD Protection: Human Body Model; > 1.0 KV
  Machine Model; > 100 V
- PECL Mode Operating Range: V_{CC} = 4.2 V to 5.7 V with V_{EE} = 0 V
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = −4.2 V to −5.7 V
- Internal Input Pulldown Resistors
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1
  For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL 94 V−0 @ 0.125 in,
  Oxygen Index: 28 to 34
- Transistor Count = 47 devices
- Pb−Free Packages are Available

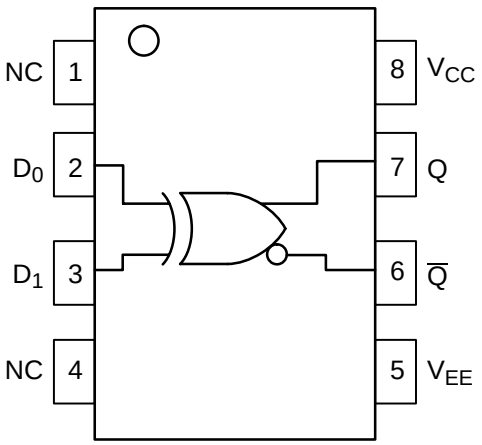

Figure 1. Logic Diagram and Pinout Assignment

PIN DESCRIPTION

PIN	FUNCTION
D0, D1	ECL Data Inputs
Q, $\overline{Q}$	ECL Data Outputs
V_{CC}	Positive Supply
V_{EE}	Negative Supply
NC	No Connect

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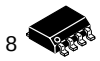
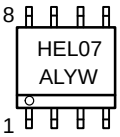
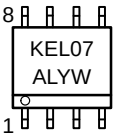
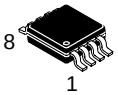
MARKING DIAGRAMS*



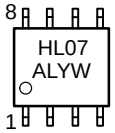
SOIC−8
D SUFFIX
CASE 751

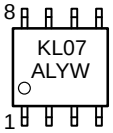






TSSOP−8
DT SUFFIX
CASE 948R





H = MC10
K = MC100
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

Device	Package	Shipping†
MC10EL07D	SOIC−8	98 Units / Rail
MC10EL07DR2G	SOIC−8 (Pb−Free)	2500 Tape & Reel
MC100EL07DG	SOIC−8 (Pb−Free)	98 Units / Rail
MC100EL07DR2G	SOIC−8 (Pb−Free)	2500 Tape & Reel
MC10EL07DT	TSSOP−8	98 Units / Rail
MC10EL07DTR2	TSSOP−8	2500 Tape & Reel
MC100EL07DT	TSSOP−8	98 Units / Rail
MC100EL07DTR2	TSSOP−8	2500 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V_{CC}	PECL Mode Power Supply	V_{EE} = 0 V		8	V
V_{EE}	NECL Mode Power Supply	V_{CC} = 0 V		−8	V
V_I	PECL Mode Input Voltage NECL Mode Input Voltage	V_{EE} = 0 V V_{CC} = 0 V	$V_I \leq V_{CC}$ $V_I \geq V_{EE}$	6 −6	V V
I_{out}	Output Current	Continuous Surge		50 100	mA mA
T_A	Operating Temperature Range			−40 to +85	°C
T_{stg}	Storage Temperature Range			−65 to +150	°C
θ_{JA}	Thermal Resistance (Junction−to−Ambient)	0 lfpm 500 lfpm	SOIC−8 SOIC−8	190 130	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction−to−Case)	Standard Board	SOIC−8	41 to 44	°C/W
θ_{JA}	Thermal Resistance (Junction−to−Ambient)	0 lfpm 500 lfpm	TSSOP−8 TSSOP−8	185 140	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction−to−Case)	Standard Board	TSSOP−8	41 to 44 ± 5%	°C/W
T_{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If stress limits are exceeded device functional operation is not implied, damage may occur and reliability may be affected. Functional operation should be restricted to the Recommended Operating Conditions.

10EL SERIES PECL DC CHARACTERISTICS V_{CC}= 5.0 V; V_{EE}= 0.0 V (Note 1)

		−40°C			25°C			85°C			
Symbol	Characteristic	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit
I_{EE}	Power Supply Current		14	17		14	17		14	17	mA
V_{OH}	Output HIGH Voltage (Note 4)	3920	4010	4110	4020	4105	4190	4090	4185	4280	mV
V_{OL}	Output LOW Voltage (Note 2)	3050	3200	3350	3050	3210	3370	3050	3227	3405	mV
V_{IH}	Input HIGH Voltage	3770		4110	3870		4190	3940		4280	mV
V_{IL}	Input LOW Voltage	3050		3500	3050		3520	3050		3555	mV
I_{IH}	Input HIGH Current D0 D1			 250 150			 250 150			 250 150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.3			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with V_{CC}.
   V_{EE} can vary +0.25 V / −0.5 V for +25°C and +85°C. or V_{EE} can vary +0.06 V / −0.5 V for −40°C.
2. Outputs are terminated through a 50 Ω resistor to V_{CC} − 2 volts.

10EL SERIES NECL DC CHARACTERISTICS V_{CC}= 0.0 V; V_{EE}= −5.0 V (Note 3)

		−40°C			25°C			85°C			
Symbol	**Characteristic**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**
I_{EE}	Power Supply Current		14	17		14	17		14	17	mA
V_{OH}	Output HIGH Voltage (Note 4)	−1080	−990	−890	−980	−895	−810	−910	−815	−720	mV
V_{OL}	Output LOW Voltage (Note 4)	−1950	−1800	−1650	−1950	−1790	−1630	−1950	−1773	−1595	mV
V_{IH}	Input HIGH Voltage	−1230		−890	−1130		−810	−1060		−720	mV
V_{IL}	Input LOW Voltage	−1950		−1500	−1950		−1480	−1950		−1445	mV
I_{IH}	Input HIGH Current D0 D1			 250 150			 250 150			 250 150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.3			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. Input and output parameters vary 1:1 with V_{CC}.
   V_{EE} can vary +0.25 V / −0.5 V for +25°C and +85°C. or V_{EE} can vary +0.06 V / −0.5 V for −40°C.
4. Outputs are terminated through a 50 Ω resistor to V_{CC} − 2 volts

100EL SERIES PECL DC CHARACTERISTICS V_{CC}= 5.0 V; V_{EE}= 0.0 V (Note 5)

		−40°C			25°C			85°C			
Symbol	**Characteristic**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Unit**
I_{EE}	Power Supply Current		14	17		14	17		16	20	mA
V_{OH}	Output HIGH Voltage (Note 6)	3915	3995	4120	3975	4045	4120	3975	4050	4120	mV
V_{OL}	Output LOW Voltage (Note 6)	3170	3305	3445	3190	3295	3380	3190	3295	3380	mV
V_{IH}	Input HIGH Voltage	3835		4120	3835		4120	3835		4120	mV
V_{IL}	Input LOW Voltage	3190		3525	3190		3525	3190		3525	mV
I_{IH}	Input HIGH Current D0 D1			 250 150			 250 150			 250 150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.5			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.8 V / −0.5 V.
6. Outputs are terminated through a 50 Ω resistor to V_{CC} − 2 volts

100EL SERIES NECL DC CHARACTERISTICS V_{CC}= 0.0 V; V_{EE}= −5.0 V (Note 7)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		14	17		14	17		16	20	mA
V_{OH}	Output HIGH Voltage (Note 8)	−1085	−1005	−880	−1025	−955	−880	−1025	−955	−880	mV
V_{OL}	Output LOW Voltage (Note 8)	−1830	−1695	−1555	−1810	−1705	−1620	−1810	−1705	−1620	mV
V_{IH}	Input HIGH Voltage	−1165		−880	−1165		−880	−1165		−880	mV
V_{IL}	Input LOW Voltage	−1810		−1475	−1810		−1475	−1810		−1475	mV
I_{IH}	Input HIGH Current D0 D1			 250 150			 250 150			 250 150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.5			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

7. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.8 V / −0.5 V.
8. Outputs are terminated through a 50 Ω resistor to V_{CC} − 2 volts

AC CHARACTERISTICS V_{CC}= 5.0 V; V_{EE}= 0.0 V or V_{CC}= 0.0 V; V_{EE}= −5.0 V (Note 9)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f_{max}	Maximum Toggle Frequency					> 2					GHz
t_{PLH} t_{PHL}	Propagation Delay to Output	90	250	435	150	260	395	170	280	415	ps
t_{JITTER}	Random Clock Jitter		0.5			0.5			0.5		ps
t_r t_f	Output Rise/Fall Times Q (20% − 80%)	100	225	350	100	225	350	100	225	350	ps

9. 10 Series: V_{EE} can vary +0.25 V / −0.5 V for +25°C and +85°C. or V_{EE} can vary +0.06 V / −0.5 V for −40°C.
   100 Series: V_{EE} can vary +0.8 V / −0.5 V.

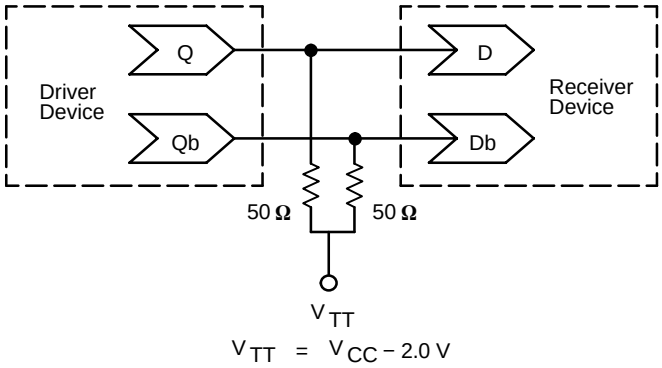


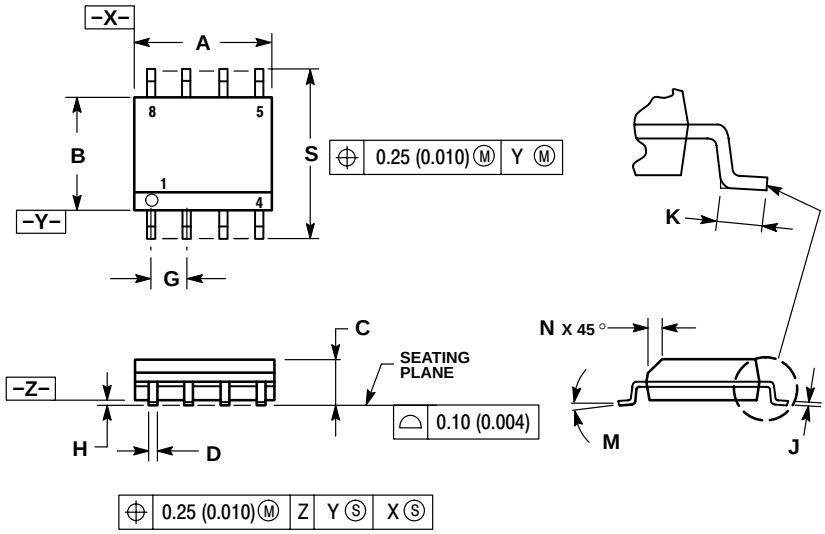
Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 − Termination of ECL Logic Devices.)

Resource Reference of Application Notes

AN1405	−	ECL Clock Distribution Techniques
AN1406	−	Designing with PECL (ECL at +5.0 V)
AN1503	−	ECLinPS I/O SPICE Modeling Kit
AN1504	−	Metastability and the ECLinPS Family
AN1568	−	Interfacing Between LVDS and ECL
AN1672	−	The ECL Translator Guide
AND8001	−	Odd Number Counters Design
AND8002	−	Marking and Date Codes
AND8020	−	Termination of ECL Logic Devices
AND8066	−	Interfacing with ECLinPS
AND8090	−	AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

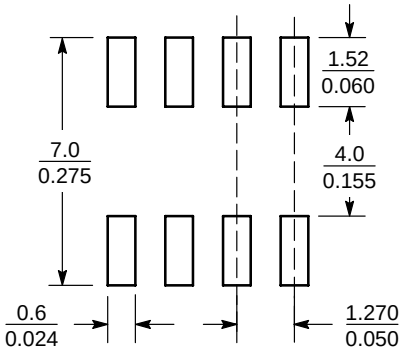
SOIC−8
D SUFFIX
CASE 751−07
ISSUE AB



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751−01 THRU 751−06 ARE OBSOLETE. NEW STANDARD IS 751−07.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

SOLDERING FOOTPRINT*



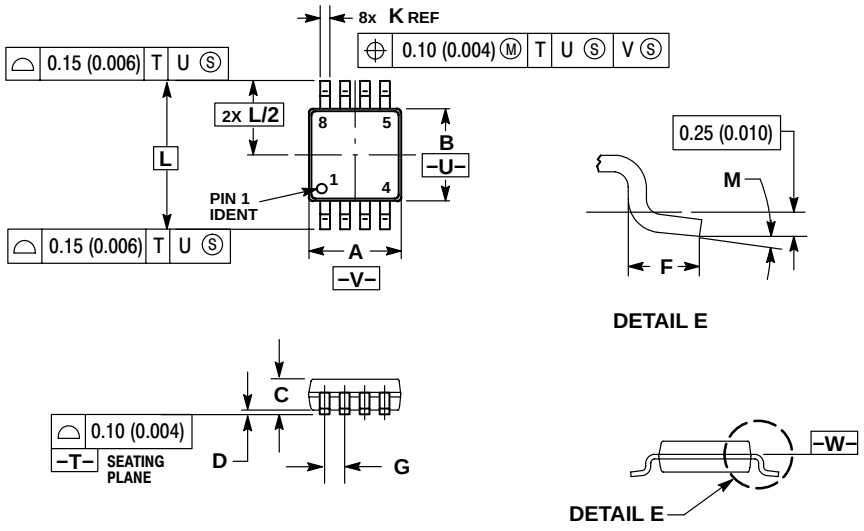
SCALE 6:1 $\left(\frac{\text{mm}}{\text{inches}}\right)$

SOIC−8

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TSSOP−8
DT SUFFIX
CASE 948R−02
ISSUE A



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE −W−.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	2.90	3.10	0.114	0.122
B	2.90	3.10	0.114	0.122
C	0.80	1.10	0.031	0.043
D	0.05	0.15	0.002	0.006
F	0.40	0.70	0.016	0.028
G	0.65 BSC		0.026 BSC	
K	0.25	0.40	0.010	0.016
L	4.90 BSC		0.193 BSC	
M	0°	6°	0°	6°

PUBLICATION ORDERING INFORMATION

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MC10EL07/D